

1. Safety Precautions

1-1. Repair Precaution

Before attempting any repair or detailed tuning, shield the device from RF noise or static electricity discharges.

Use only demagnetized tools that are specifically designed for small electronic repairs, as most electronic parts are sensitive to electromagnetic forces.

Use only high quality screwdrivers when servicing products. Low quality screwdrivers can easily damage the heads of screws.

Use only conductor wire of the properly gauge and insulation for low resistance, because of the low margin of error of most testing equipment.

We recommend 22-gauge twisted copper wire.

Hand-soldering is not recommended, because printed circuit boards (PCBs) can be easily damaged, even with relatively low heat. Never use a soldering iron with a power rating of more than 100 watts and use only lead-free solder with a melting point below 250°C (482°F).

Prior to disassembling the battery charger for repair, ensure that the AC power is disconnected.

Always use the replacement parts that are registered in the SEC system. Third-party replacement parts may not function properly.

1. Safety Precautions

1-2. ESD(Electrostatically Sensitive Devices) Precaution

Many semiconductors and ESDs in electronic devices are particularly sensitive to static discharge and can be easily damaged by it. We recommend protecting these components with conductive anti-static bags when you store or transport them.

Always use an anti-static strap or wristband and remove electrostatic buildup or dissipate static electricity from your body before repairing ESDs.

Ensure that soldering irons have AC adapter with ground wires and that the ground wires are properly connected.

Use only desoldering tools with plastic tips to prevent static discharge.

Properly shield the work environment from accidental electrostatic discharge before opening packages containing ESDs.

The potential for static electricity discharge may be increased in low humidity environments, such as air-conditioned rooms. Increase the airflow to the working area to decrease the chance of accidental static electricity discharges.

2. Specification

2-1. GSM General Specification

Item		GSM 850	EGSM 900	DCS1800	PCS1900
Freq. Band[MHz]		824~849	880~915	1710~1785	1850~1910
Uplink/Downlink		869~894	925~960	1805~1880	1930~1990
ARFCN range		128~251	0~124 & 975~1023	512~885	512~810
Tx/Rx spacing		45MHz	45MHz	95MHz	80MHz
Mod. Bit rate/ Bit Period		270.833kbps 3.692us	270.833kbps 3.692us	270.833kbps 3.692us	270.833kbps 3.692us
Time Slot Period/ Frame Period		576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms
Modulation	GSM/ EGPRS	GMSK/ 8PSK	GMSK/ 8PSK	GMSK/ 8PSK	GMSK/ 8PSK
MS Power		33dBm~5dBm	33dBm~5dBm	30dBm~0dBm	30dBm~0dBm
Power Class		4(GMSK) E2(8PSK)	4(GMSK) E2(8PSK)	1(GMSK) E2(8PSK)	1(GMSK) E2(8PSK)
Sensitivity		-102dBm	-102dBm	-100dBm	-100dBm
TDMA Mux		8	8	8	8

2. Specification

2-2. GSM Tx Power Class

TX Power control level	GSM850	TX Power control level	EGSM900	TX Power control level	DCS1800	TX Power control level	PCS1900
5	33±2 dBm	5	33±2 dBm	0	30±3 dBm	0	30±3 dBm
6	31±2 dBm	6	31±2 dBm	1	28±3 dBm	1	28±3 dBm
7	29±2 dBm	7	29±2 dBm	2	26±3 dBm	2	26±3 dBm
8	27±2 dBm	8	27±2 dBm	3	24±3 dBm	3	24±3 dBm
9	25±2 dBm	9	25±2 dBm	4	22±3 dBm	4	22±3 dBm
10	23±2 dBm	10	23±2 dBm	5	20±3 dBm	5	20±3 dBm
11	21±2 dBm	11	21±2 dBm	6	18±3 dBm	6	18±3 dBm
12	19±2 dBm	12	19±2 dBm	7	16±3 dBm	7	16±3 dBm
13	17±2 dBm	13	17±2 dBm	8	14±3 dBm	8	14±3 dBm
14	15±2 dBm	14	15±2 dBm	9	12±4 dBm	9	12±4 dBm
15	13±2 dBm	15	13±2 dBm	10	10±4 dBm	10	10±4 dBm
16	11±3 dBm	16	11±3 dBm	11	8±4 dBm	11	8±4 dBm
17	9±3 dBm	17	9±3 dBm	12	6±4 dBm	12	6±4 dBm
18	7±3 dBm	18	7±3 dBm	13	4±4 dBm	13	4±4 dBm
19	5±3 dBm	19	5±3 dBm	14	2±5 dBm	14	2±5 dBm
-	-	-	-	15	0±5 dBm	15	0±5 dBm

2. Specification

2-3. WCDMA General Specification

Item	WCDMA2100(B1)	WCDMA1900(B2)	WCDMA AWS(B4)	WCDMA850(B5)	WCDMA900(B8)
Freq. Band[MHz] Uplink/Downlink	1920~1980 2110~2170	1850~1910 1930~1990	1710~1755 2110~2155	824~849 869~894	880~915 925~960
ARFCN range	UL: 9612~9888 DL: 10562~10838	UL: 9262~9538 DL: 9662~9938	UL: 1312~1513 DL: 1537~1738	UL: 4132~4233 DL: 4357~4458	UL: 2712~2868 DL: 2937~3088
Tx/Rx spacing	190MHz	80MHz	400MHz	45MHz	45MHz
Mod. Bit rate/ Bit Period	42.2Mbps(DL) 5.42Mbps(UL)	42.2Mbps(DL) 5.42Mbps(UL)	42.2Mbps(DL) 5.42Mbps(UL)	42.2Mbps(DL) 5.42Mbps(UL)	42.2Mbps(DL) 5.42Mbps(UL)
Time Slot Period/ Frame Period	WCDMA 10ms/0.667ms HSPA 2ms/0.667ms	WCDMA 10ms/0.667ms HSPA 2ms/0.667ms	WCDMA 10ms/0.667ms HSPA 2ms/0.667ms	WCDMA 10ms/0.667ms HSPA 2ms/0.667ms	WCDMA 10ms/0.667ms HSPA 2ms/0.667ms
Modulation	QPSK 16QAM 64QAM	QPSK 16QAM 64QAM	QPSK 16QAM 64QAM	QPSK 16QAM 64QAM	QPSK 16QAM 64QAM
MS Power (dBm)	25.7 ~ -49(↓)	25.7 ~ -49(↓)	25.7 ~ -49(↓)	25.7 ~ -49(↓)	25.7 ~ -49(↓)
Power Class	3(max+24dBm)	3(max+24dBm)	3(max+24dBm)	3(max+24dBm)	3(max+24dBm)
Sensitivity	-106dBm	-104dBm	-106dBm	-104dBm	-103dBm

2. Specification

2-4. LTE General Specification

Item	LTE Band1	LTE Band2	LTE Band3	LTE Band4	LTE Band5	LTE Band7
Freq. Band[MHz]	1920~1980	1850~1910	1710~1785	1710~1755	824~849	2500~2570
Uplink/Downlink	2110~2170	1930~1990	1805~1880	2110~2155	869~894	2620~2690
ARFCN range	UL:18000~18599 DL:0~599	UL:18600~19199 DL:600~1199	UL:19200~19949 DL:1200~1949	UL:19950~20399 DL:1950~2399	UL:20400~20649 DL:2400~2649	UL:20750~21449 DL:2750~3449
Tx/Rx spacing (MHz)	190	80	95	400	45	120
Channel Bandwidth (MHz)	5/10/15/20	1.4/3/5/10/15/20	1.4/3/5/10/15/20	1.4/3/5/10/15/20	1.4/3/5/10	5/10/15/20
Modulation	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)
MS Power (dBm)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)
Sensitivity (QPSK, BW 10MHz)(dBm)	-96.3	-94.3	-93.3	-96.3	-94.3	-94.3

Item	LTE Band8	LTE Band12	LTE Band13	LTE Band14	LTE Band18	LTE Band19
Freq. Band[MHz]	880~915	699~716	777~787	788~798	815~830	830~845
Uplink/Downlink	925~960	729~746	746~756	758~768	860~875	875~890
ARFCN range	UL:21450~21799 DL:3450~3799	UL:23010~23179 DL:5010~5179	UL:23180~23279 DL:5180~5279	UL:23280~23379 DL:5280~5379	UL:23850~23999 DL:5850~5999	UL:24000~24149 DL:6000~6149
Tx/Rx spacing (MHz)	45	30	-31	-30	45	45
Channel Bandwidth (MHz)	1.4/3/5/10	1.4/3/5/10	1.4/3/5/10	5/10	5/10/15	5/10/15
Modulation	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)
MS Power (dBm)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)
Sensitivity (QPSK, BW 10MHz) (dBm)	-93.3	-93.3	-93.3	-93.3	-96.3	-96.3

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2. Specification

Item	LTE Band20	LTE Band25	LTE Band26	LTE Band28	LTE Band30	LTE Band34
Freq. Band[MHz] Uplink/Downlink	832~862 791~821	1850~1915 1930~1995	814~849 859~894	703~748 758~803	2305~2315 2350~2360	2010~2025
ARFCN range	UL:24150~24449 DL:6150~6449	UL:26040~26689 DL:8040~8689	UL:26690~27039 DL:8690~9039	UL:27210~27659 DL:9210~9659	UL:27660~27759 DL:9770~9869	UL/DL:36200~ 36349
Tx/Rx spacing (MHz)	-41	80	45	55	35	0
Channel Bandwidth(MHz)	5/10/15/20	1.4/3/5/10/15/20	1.4/3/5/10/15	3/5/10/15/20	5/10	5/10/15
Modulation	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)
MS Power (dBm)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)
Sensitivity (QPSK, BW 10MHz)(dBm)	-93.3	-92.8	-93.8	-94.8	-96.3	-96.3

Item	LTE Band38	LTE Band39	LTE Band40	LTE Band41	LTE Band66	LTE Band71
Freq. Band[MHz] Uplink/Downlink	2570~2620	1880~1920	2300~2400	2496~2690	1710~1780 2110~2200	663~698 617~652
ARFCN range	UL/DL:37750 ~ 38249	UL/DL:38250 ~ 38649	UL/DL:38650 ~ 39649	UL/DL:39650 ~ 41589	UL:131972~132671 DL:66436 ~ 67335	UL:133122~133471 DL:68586~68935
Tx/Rx spacing (MHz)	0	0	0	0	400	-46
Channel Bandwidth(MHz)	5/10/15/20	5/10/15/20	5/10/15/20	5/10/15/20	1.4/3/5/10/15/20	5/10/15/20
Modulation	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)	QPSK, 16/64QAM 256QAM(DL only)
MS Power (dBm)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)	25.7~-39(↓)
Sensitivity (QPSK, BW 10MHz)(dBm)	-96.3	-96.3	-96.3	-94.3	-95.8	-93.5

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2. Specification

2-5. TDSCDMA General Specification

Item	TDSCDMA2010(A)	TDSCDMA1880(F)
Chip rate	1.28 Mcps	1.28 Mcps
OBW	1.6 MHz	1.6 MHz
Freq. Band[MHz] Uplink/Downlink	2010~2025	1880~1920
ARFCN range	10054~10121	9404~9596
Tx/Rx spacing (MHz)	0	0
MS Power (dBm)	25.7 ~ -48(↓)	25.7 ~ -48(↓)
Power Class	2(max+24dBm)	2(max+24dBm)
Sensitivity (dBm /1.28 MHz)	-107.3	-107.3

3. Product Function

Main Function

Item	Description
OS	Android V9.0
RF	GSM Quad (GSM850 / GSM900 / DCS1800 / PCS1900) WCDMA: B1/ B2/ B4/ B5/ B8 TDSCDMA : B34/ B39 LTE: B1/ B2/ B3/ B4/ B5/ B7/ B8/ B12/ B13/ B14/ B18/ B19/ B20/ B25/ B26/ B28/ B29/ B30/ B38/ B39/ B40/ B41/ B66/ B71
Battery	Typ. 4380mAh (Main 2245mAh, Sub 2135mAh) Rated. 4275mAh (Main 2190mAh, Sub 2085mAh)
Base Band	Up to 2.8Ghz / mid 2.4 / lit 1.7
Other RF	A-GPS, Glonass, BEIDOU, Galileo, BT5.0, USB 3.1 Type-C, WIFI 802.11 a/b/g/n/ac/ax MIMO, NFC,MST
Camera	Triple Camera (Wide : 12M Dual A/F, OIS, F1.5-2.4 & Ultra Wide : 16M F/F, F2.2 & Tele : 12M A/F, OIS, F2.4) with LED Flash VT Single (10MP F/F, F2.2) VT Stereo (10MP F/F, F2.2 & 8MP F/F, F1.9)
Display	Main : 7.29" QXGA + (2048+104 X 1536, L-Cut), Foldable, 4:3 Sub : 4.577" HD + (720x1680), Y-OCTA, 21:9
RAM	12GB
Storage	512GB
Sensor	Accelerometer, Barometer, Fingerprint Sensor, Gyro Sensor, Geomagnetic Sensor, Hall Sensor, Proximity Sensor, RGB Light Sensor, Grip Sensor
Accessory	Charger: 5V/2A (AFC: 9V/1.67A) Data cable: 2.8pi, 1.2m(Type C/ USB-A) Galaxy Buds

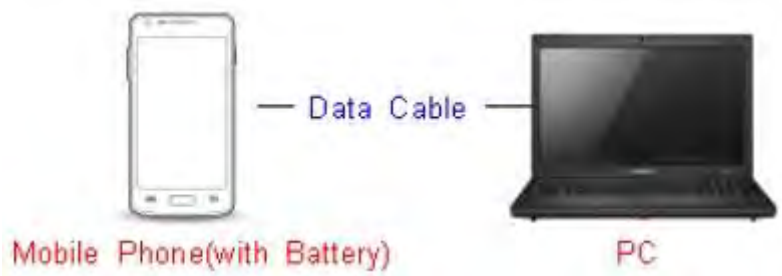
6. Level 1 Repair

6-1. S/W Update

6-1-1. Preparation

- S/W Update program : [Fenrir 5.17.xxxx](#)
- Mobile Phone
- Data Cable

※ Settings



Data Cable : [GH39-01922A](#)

6. Level 1 Repair

6-1-2. How to use 'Fenrir' S/W update program.

1) Launch Fenrir by clicking on the icon on the desktop



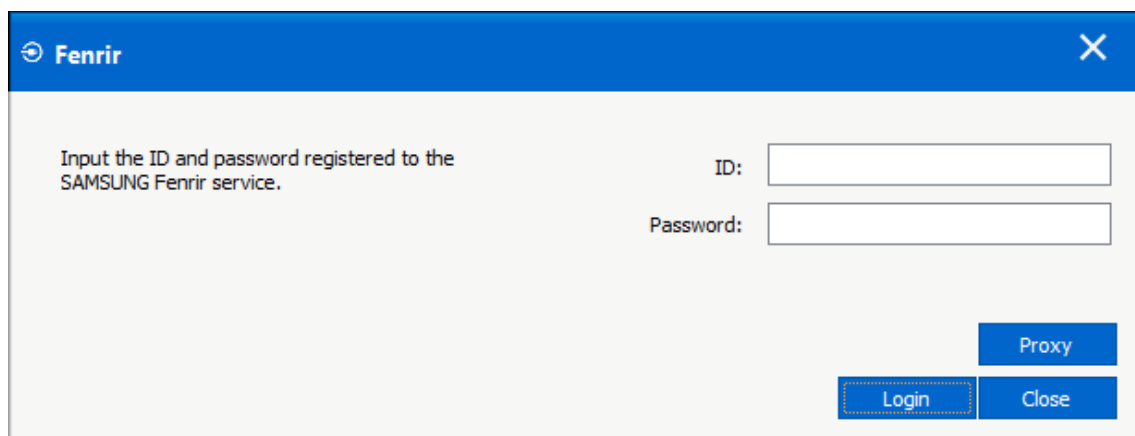
- SVH (Fenrir_Home) : It uses Home binary which does not have user data area in the memory when flashed to a device. (Keep user data)

- SVC (Fenrir_Factory) : It uses Factory binary which erases all user data in the memory when flashed to a device. (Clear user data)

- SVA (Fenrir_All) : It uses Factory and Home binaries. you can download Home and Factory binary in a PC (but requires double HDD storage and NW traffic)

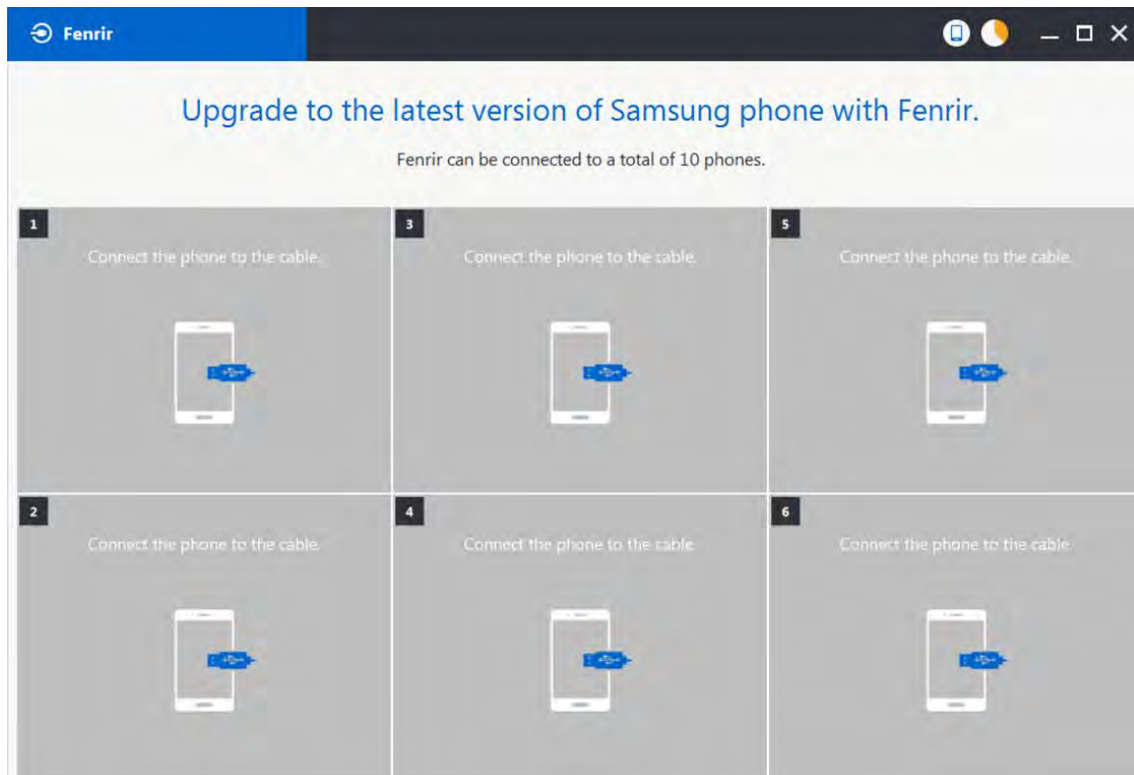
2) Input ID & password

※ You need to reset the ID information in case of PC change and format and repair, hard disk change

A screenshot of the Fenrir login window. The window has a blue title bar with the 'Fenrir' logo and a close button. The main area is white and contains the text 'Input the ID and password registered to the SAMSUNG Fenrir service.' There are two input fields: 'ID:' and 'Password:'. Below the input fields are three buttons: 'Proxy', 'Login', and 'Close'. The 'Login' button is highlighted with a dashed orange border.

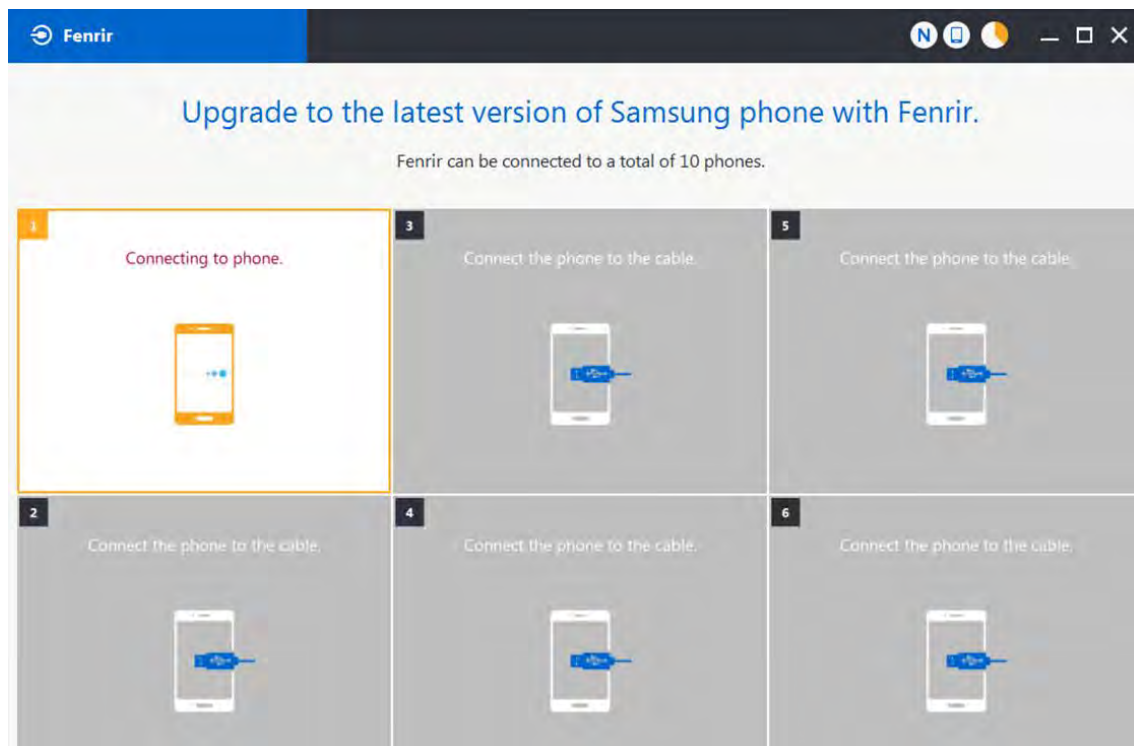
6. Level 1 Repair

3) Ensure device has sufficient charge (at least 20%) to start firmware update.



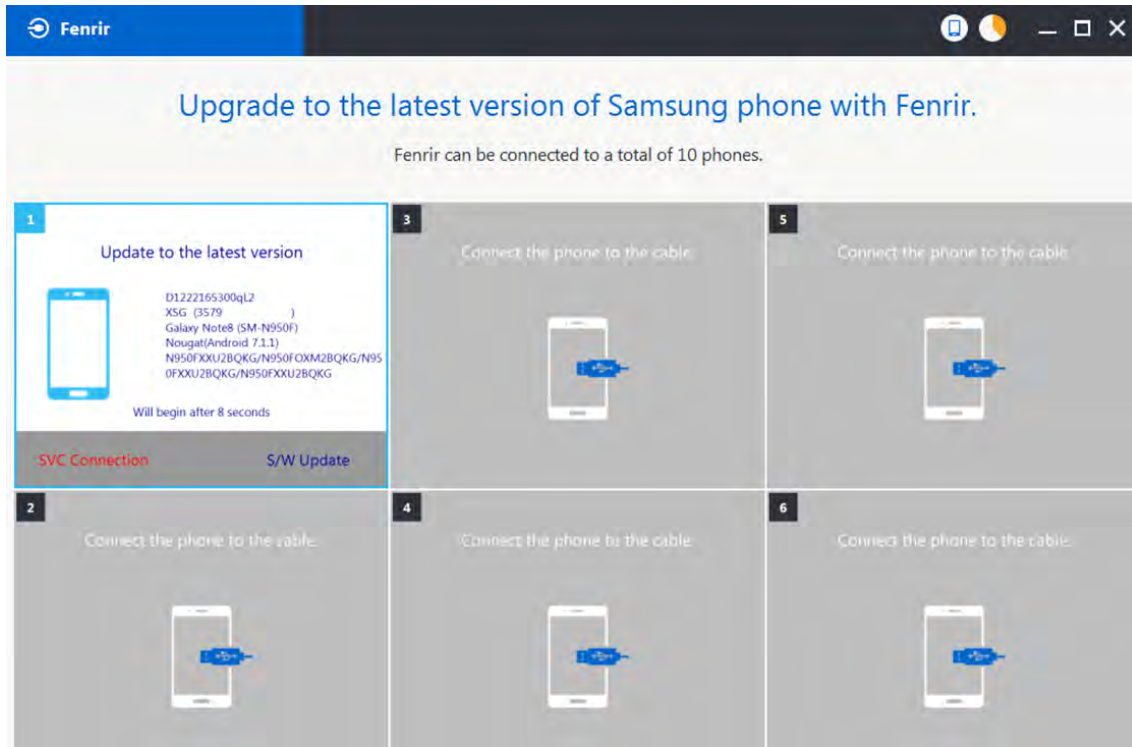
4) Connect the device to PC via data cable.

5) Upon USB connection, you will be presented with below screen.

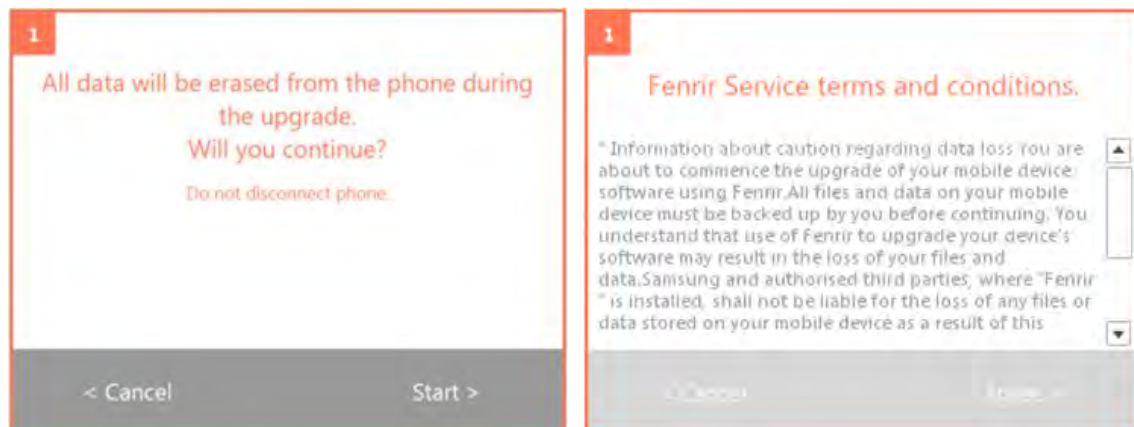


6. Level 1 Repair

6) Once device is detected, you will be presented with below screen. To update S/W, select "S/W Update" or to exit select "SVC Connection". If you select "SVC Connection", only Fenrir connection history (record) will be stored in the FUS server to support warranty validation. (This is known as "Service Connection" history)

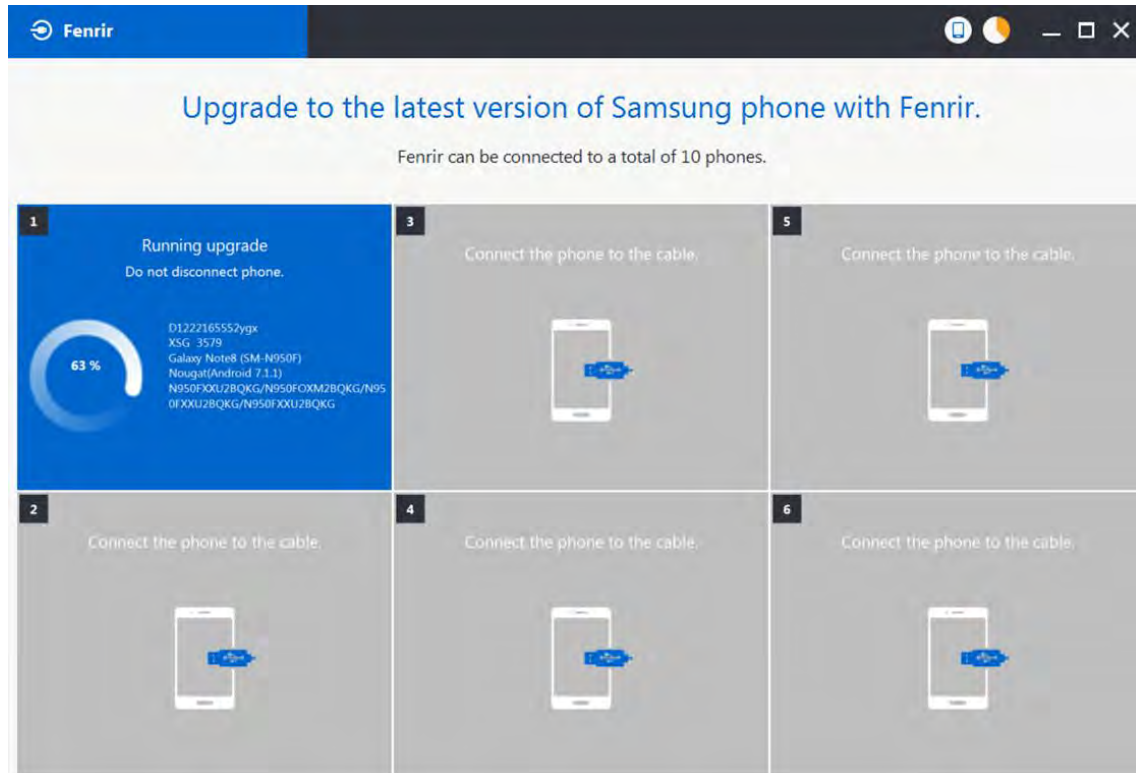


7) Once Fenrir starts, application will display the below screen. And select the Start button & Agree button.

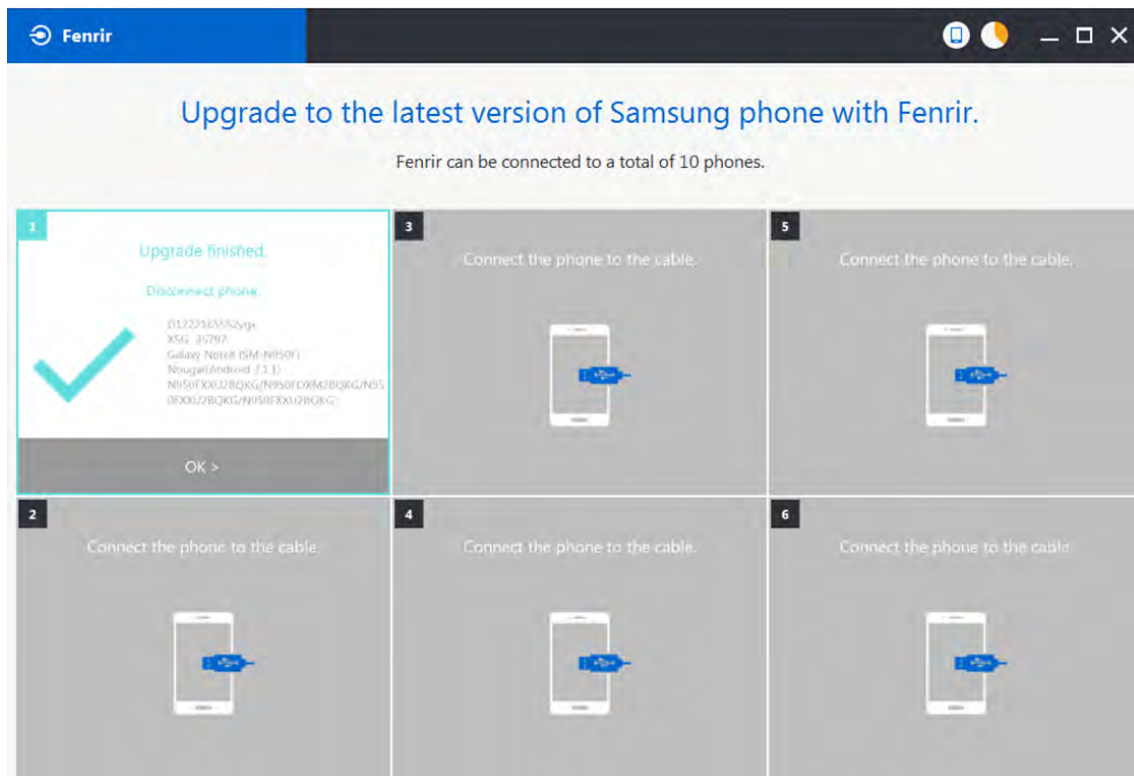


6. Level 1 Repair

8) The status circle increases as the update installs. The update process takes approximately 5-10 minutes to complete. Do not disconnect the device from USB during processing.



9) Once complete, application will present the below screen indicating update complete. Click Ok and detach device from USB.



6. Level 1 Repair

6-2. How to use 'Odin' program

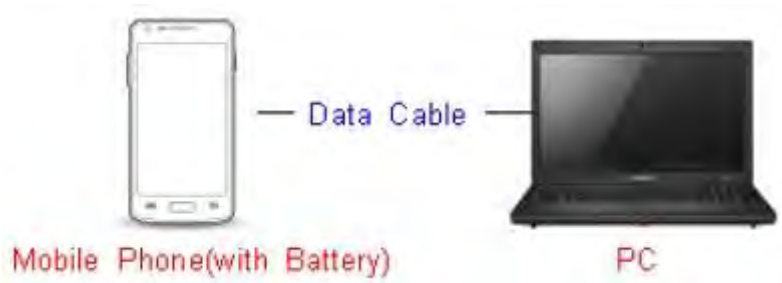
※ S/W Update via Fenrir is mandatory.

Below is the method to use 'Odin' program in any specific case.

6-2-1. Preparation

- Installation program : [Odin3 v3.13.3.exe or above](#)
- Mobile Phone
- Data Cable
- S/W Binary files (downloaded from GSPN)

※ Settings

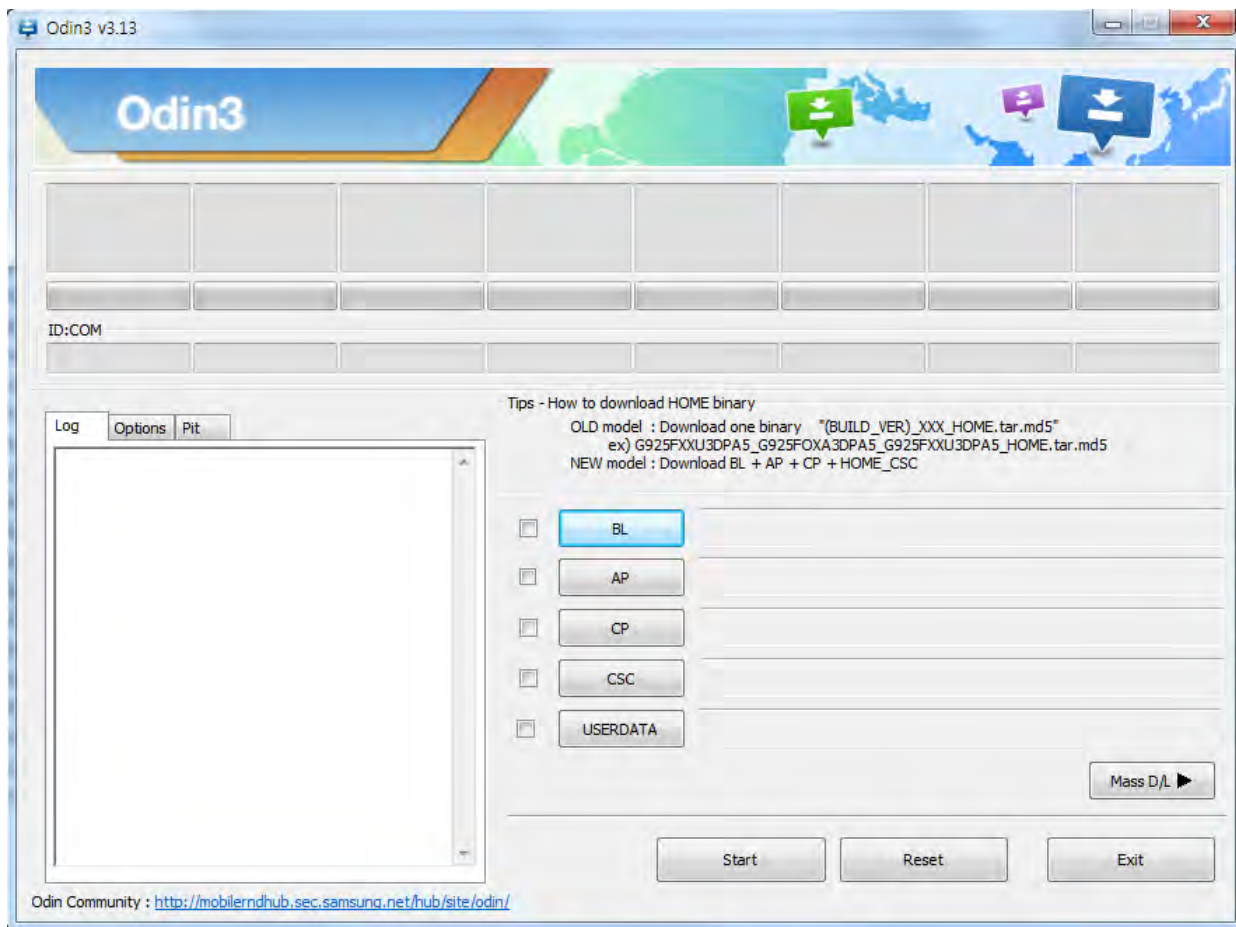


Data Cable : [GH39-01922A](#)

6. Level 1 Repair

6-2-2. S/W Installation Program (Downloader program)

Open up the S/W Installation Program by executing the "**Odin3 v3.13.3.exe**" or above

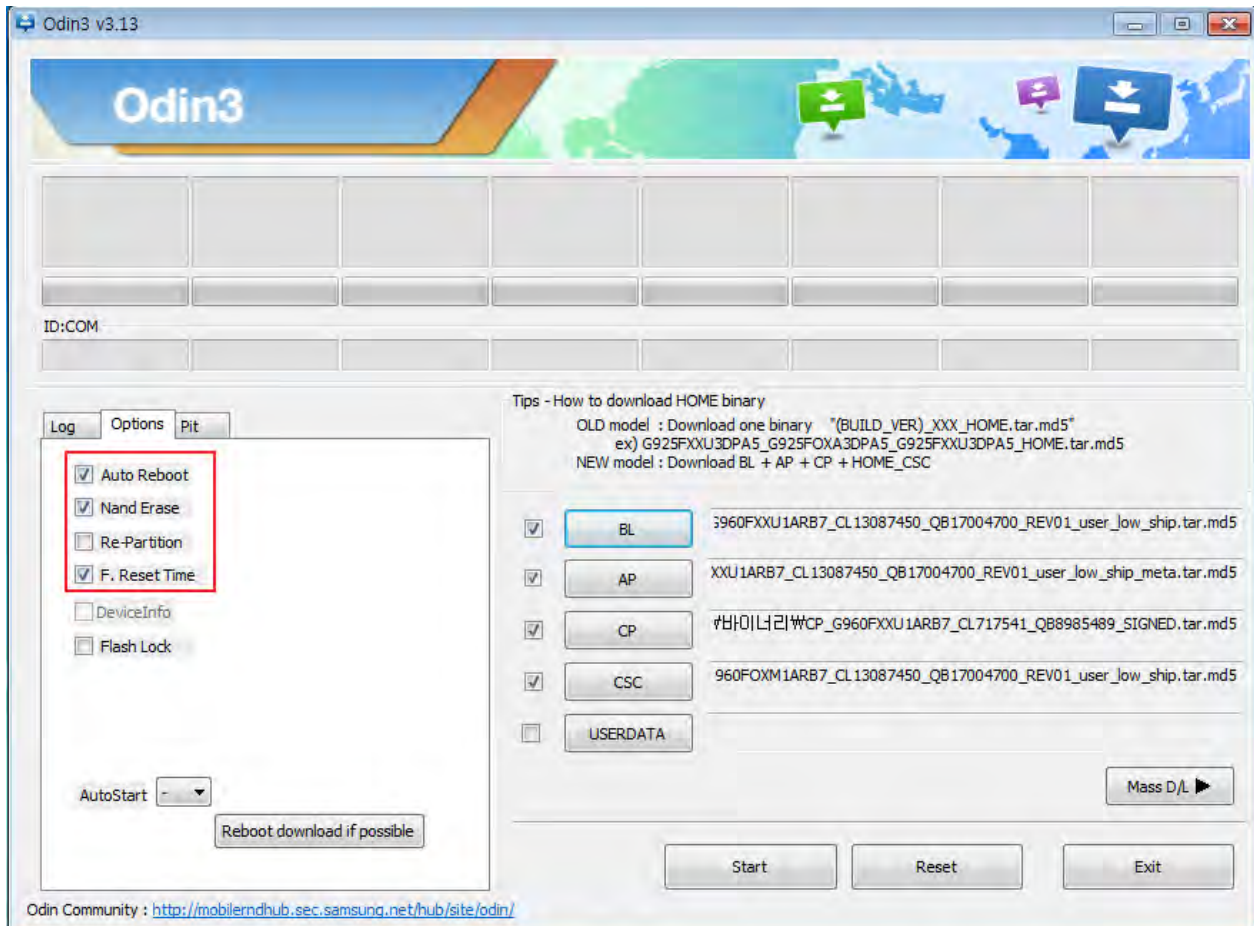


6. Level 1 Repair

1. Enable the check mark by click on the following options

- Check Auto Reboot, F. Reset Time, Nand Erase
- Check BL, AP, CP, CSC Files

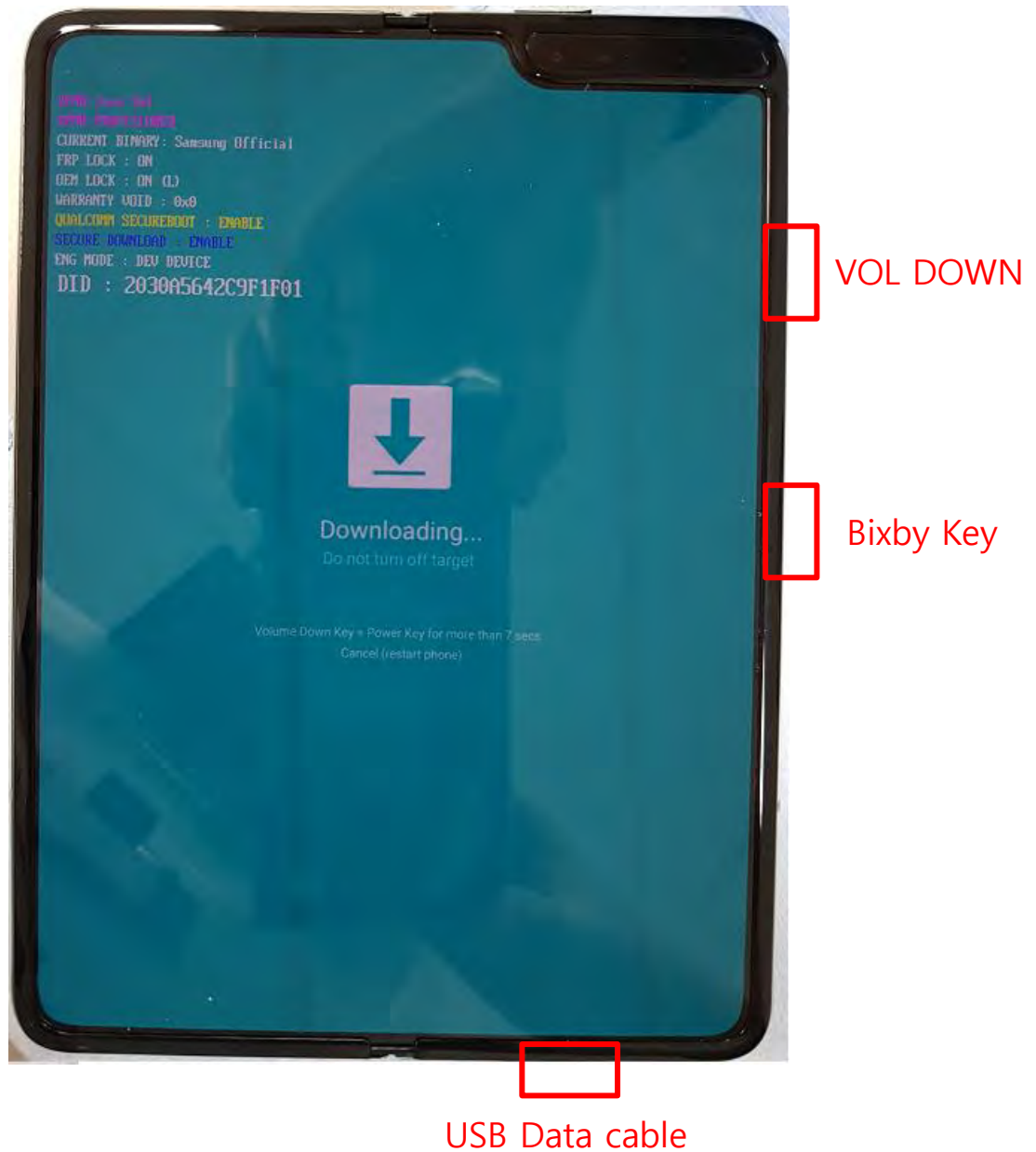
* Note : Odin PGM checks MD5 checksum just after file selection.



6. Level 1 Repair

2. Enter into Download Mode

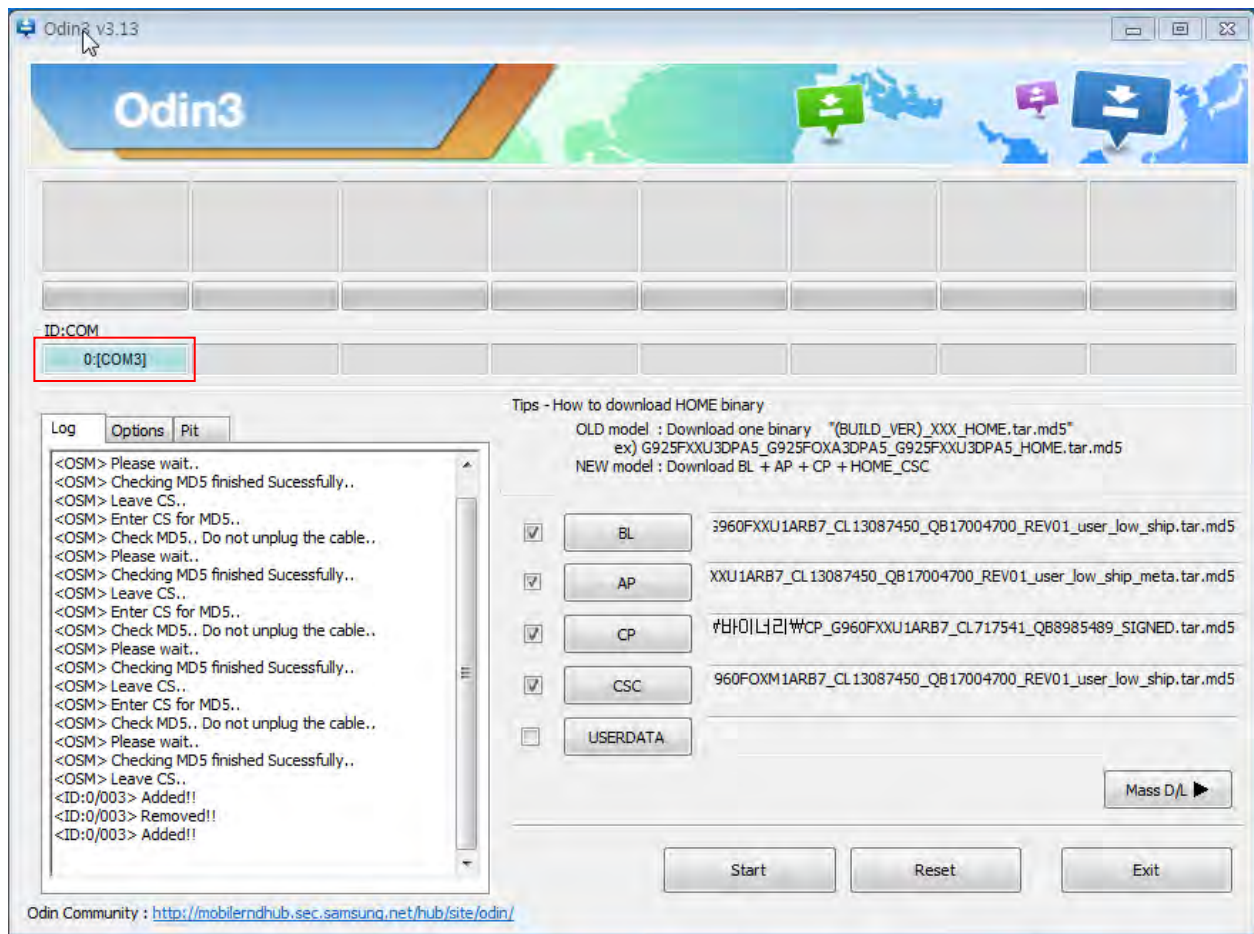
- Enter into Download Mode by pressing Volume Down button and Intelligence button simultaneously and connecting data cable followed by pressing Volume up button as a direction of the phone.



6. Level 1 Repair

3. Connect the device to PC via Data Cable.

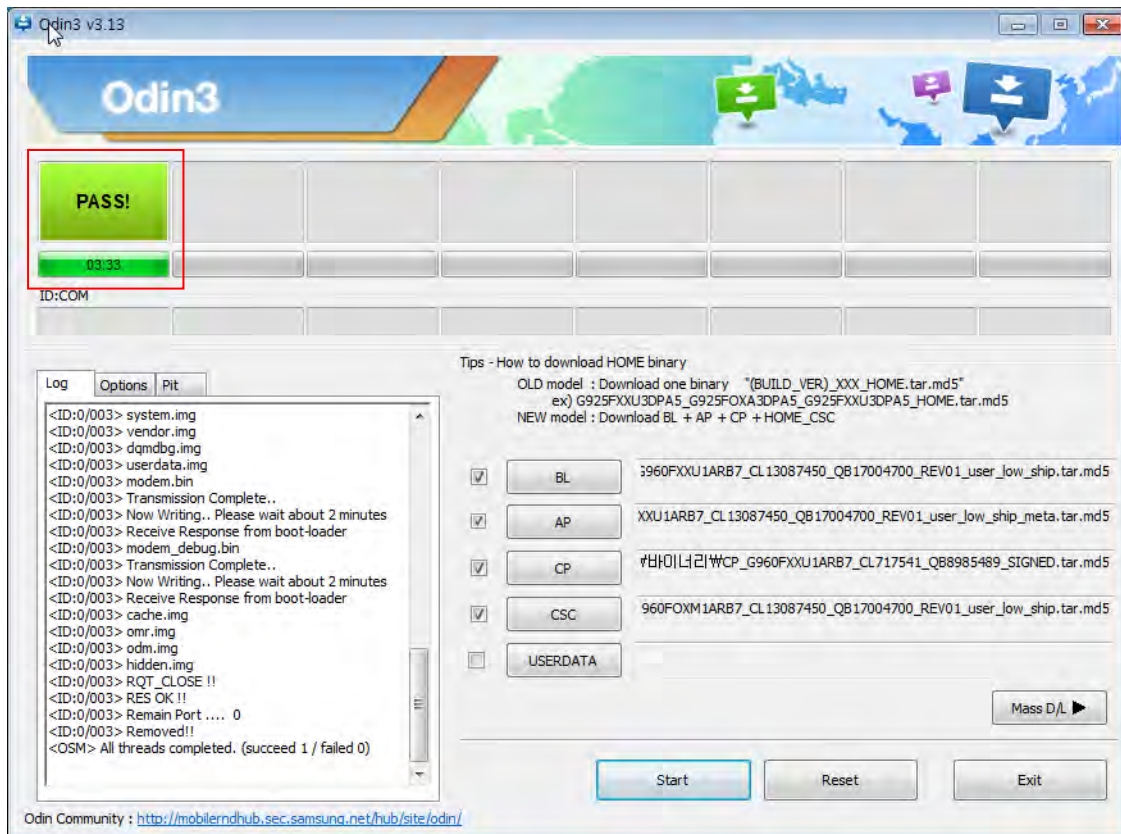
Make sure that the one of communication ports [ID:COM] box is highlighted in sky blue.
The device is now connected with the PC and ready to download the binary files in it.



6. Level 1 Repair

4. Start downloading the binary files into the device by clicking Start button on the screen.

The green colored "PASS!" sign will appear on the upper-left box if the binary files have been successfully downloaded into the device.



5. Disconnect the device from the Data cable.

6. Once the device boots up, you can check the version of the binary file or name by pressing the following code in sequence; ***#1234#**

You can perform Factory data Reset by Settings → General Management → Reset

※ Caution. Never disconnect during the S/W downloading.

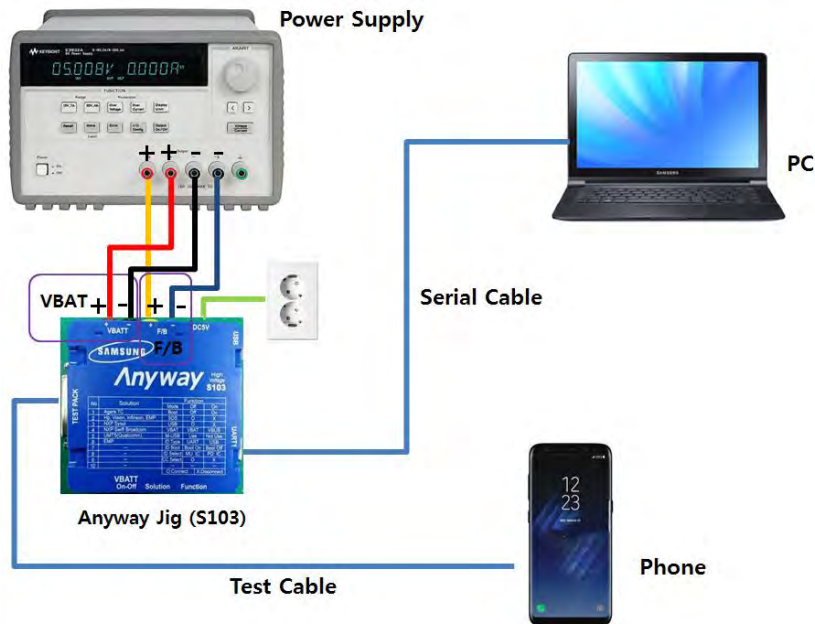
6. Level 1 Repair

6-3. IMEI writing




6-3-1. Preparation

- New IMEI writing Program has been released.
- Supported Model : Models which CAB files are uploaded on HHPsvc INI File category, instead of ini file.
- Refer to below IMEI writing procedure.

- H/W




- S/W

① Library Install	To use Daseul, library files should be installed. Refer to SVC Bulletin “(11-82) Daseul (New IMEI writing Program) Library Install guide_rev1.0”
② Launcher	DASEUL_SVC_Launcher_v3.0.12 or higher -Uploaded on HHPsvc Notice
③ Runtime File	1. DASEUL_IMEI_ALL_Runtime_3.1.405.0_r00595.CAB or higher -Uploaded on HHPsvc Notice 2. Make 'ModelName' folder at the same position with launcher & Runtime file. <div style="border: 1px solid #ccc; padding: 5px; margin-top: 10px;">  DASEUL_IMEI_ALL_Runtime_3.1.405.0_r00595  DASEUL_Launcher_v3.0.29  SM-G970F_SS(CSC)_IMEI_Ver_3.1.385.3 </div>
④ Model File	Copy Model File under the 'Model Name' folder

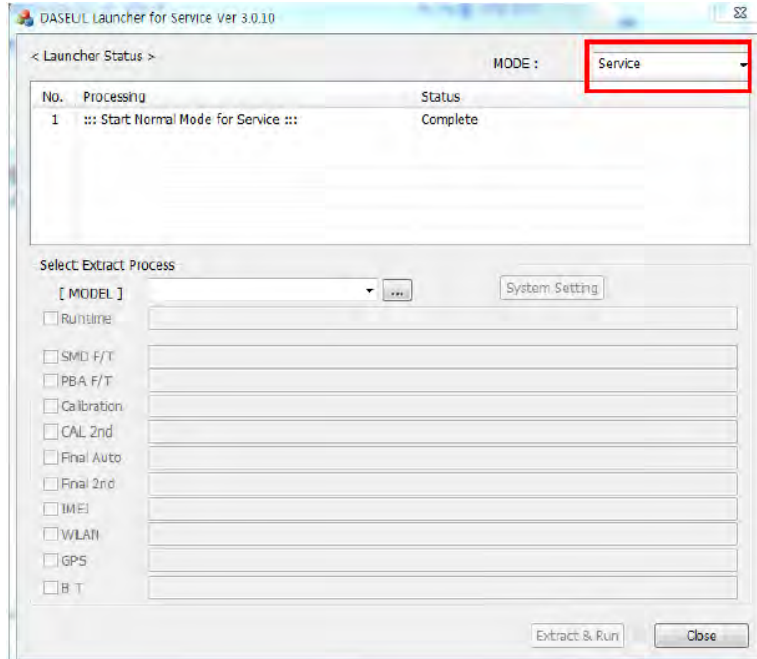
6. Level 1 Repair

6-3-2. IMEI writing Process

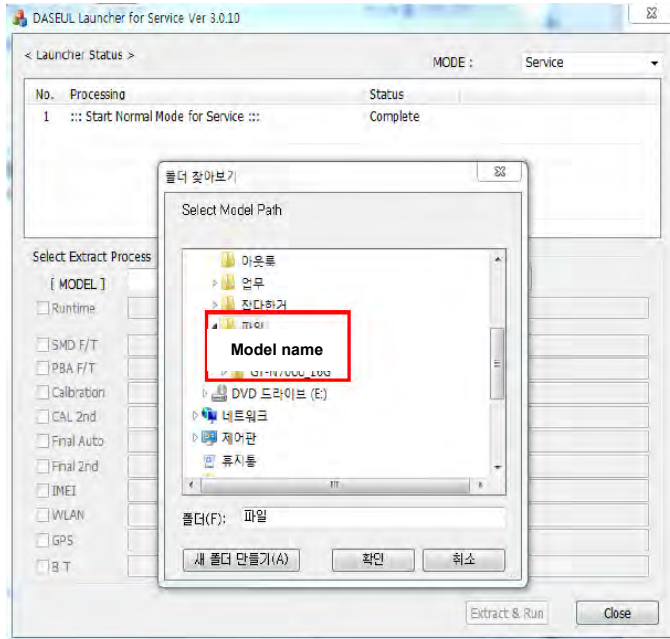
1. Run DASEUL_SVC_Launcher_v3.0.12.exe

 DASEUL_SVC_Launcher_v3.0.12.exe

2. Select Service Mode

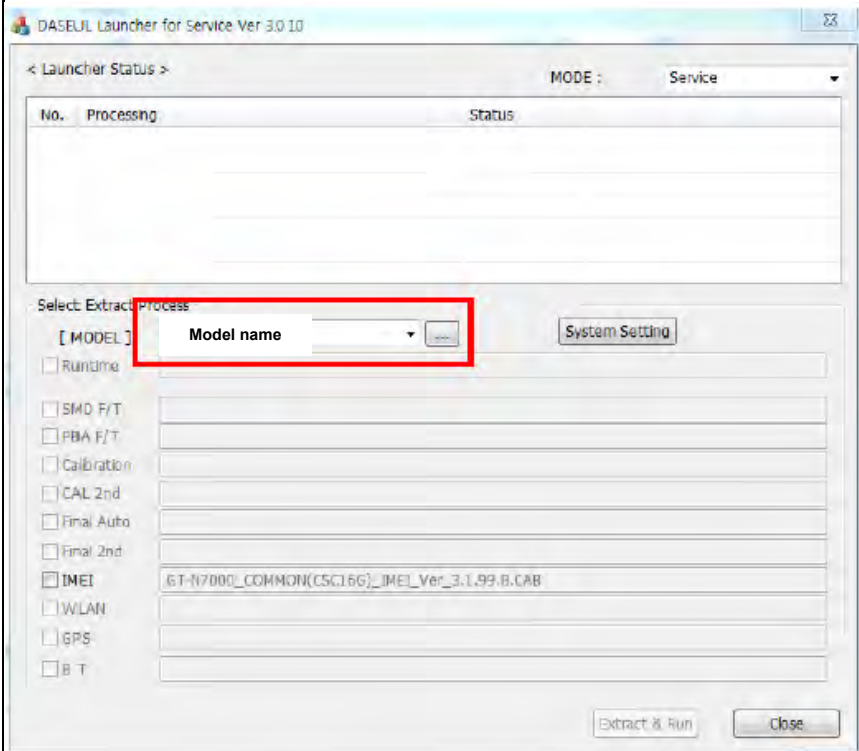


3. Click  and Select folder where the Launcher exists



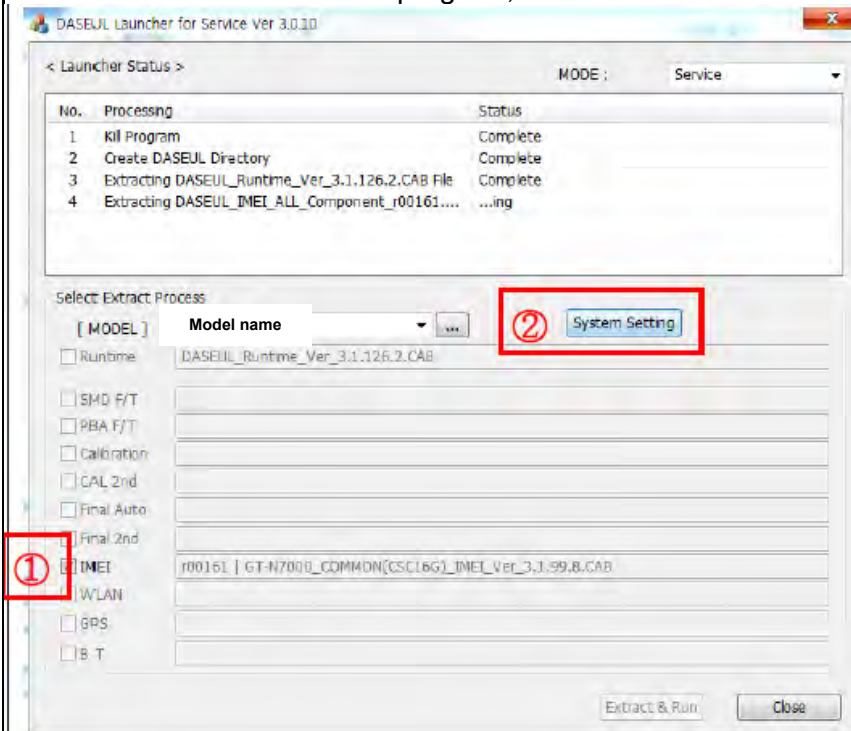
6. Level 1 Repair

4. Select Model



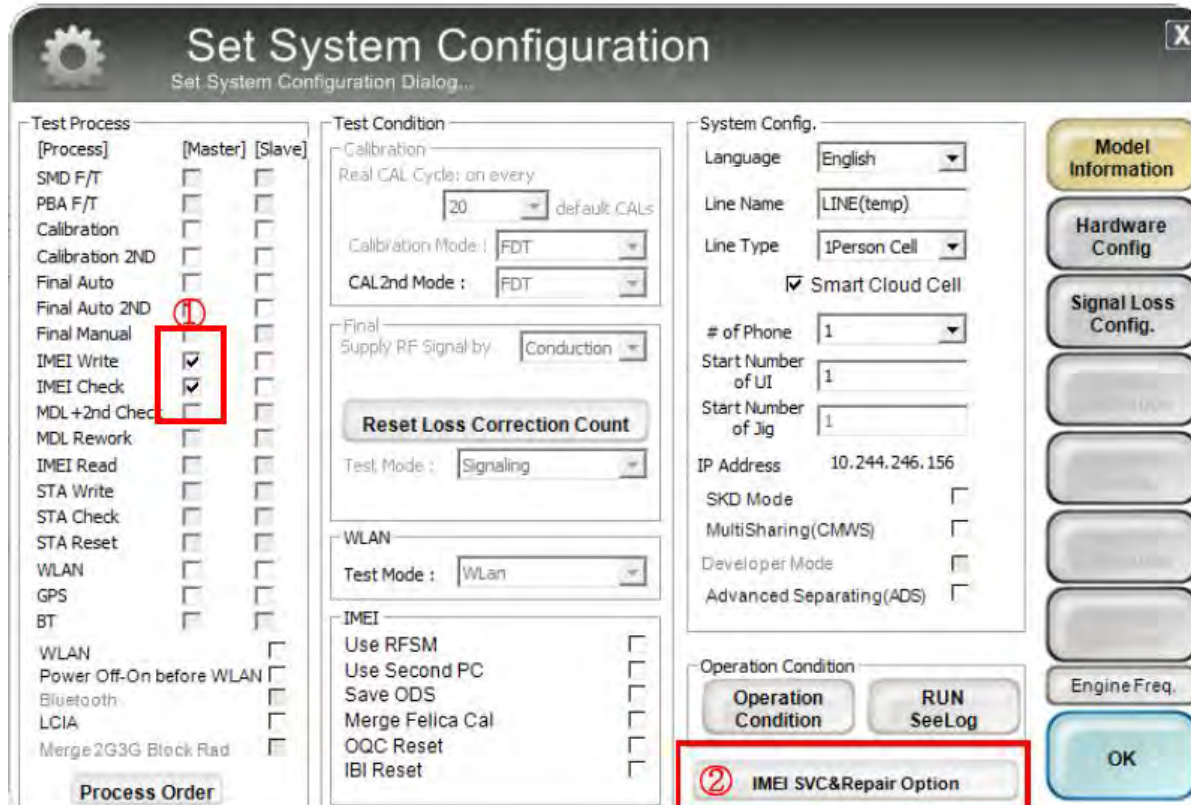
5. Check IMEI and click System Setting

※ Once you setup the setting, you don't have to do it again, unless there is change.
From second run of the IMEI program, check IMEI and click Extract & Run.



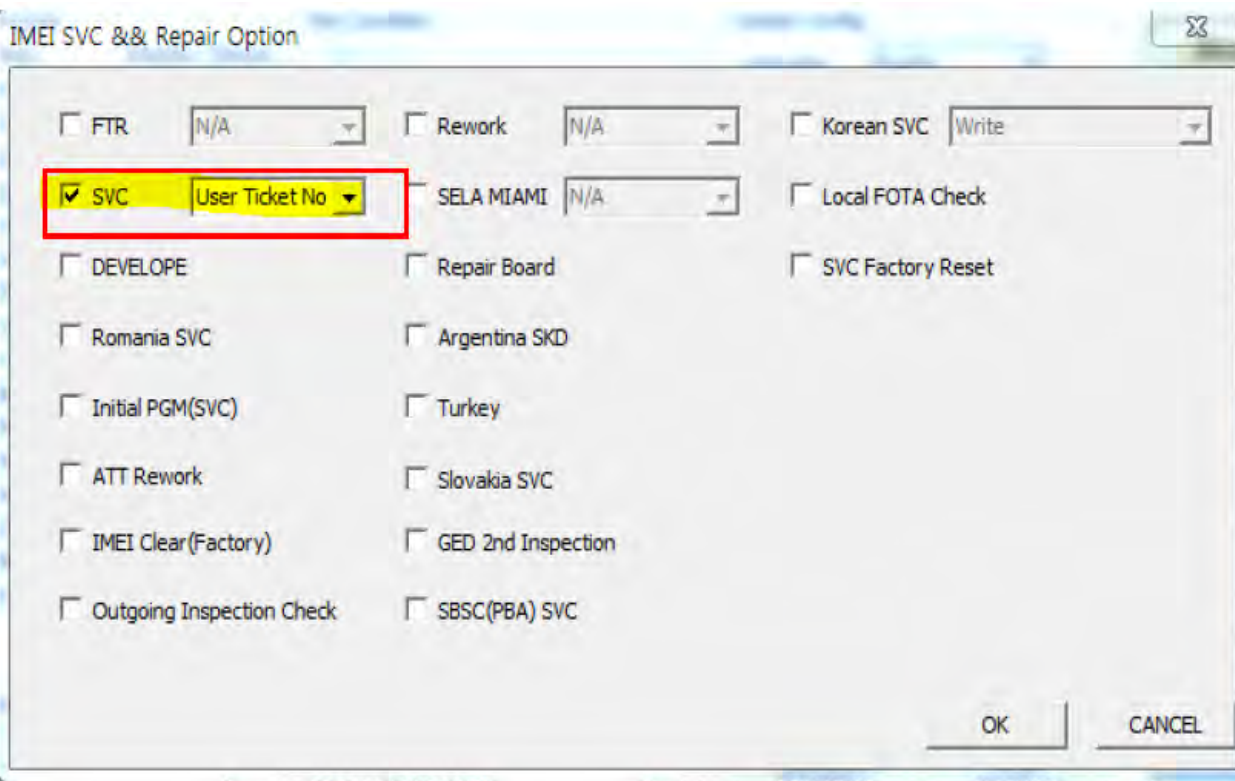
6. Level 1 Repair

6. Check IMEI Write / IMEI Check and click IMEI SVC & Repair Option.



The image shows the 'Set System Configuration' dialog box. It has several tabs: 'Test Process', 'Test Condition', 'System Config.', and 'Model Information'. The 'Test Process' tab is active, showing a list of test items with checkboxes for 'Master' and 'Slave' columns. The 'Test Condition' tab is also visible, showing settings for 'Calibration', 'WLAN', and 'IMEI'. The 'System Config.' tab is visible, showing settings for 'Language', 'Line Name', 'Line Type', 'Smart Cloud Cell', '# of Phone', 'Start Number of UI', 'Start Number of Jig', 'IP Address', 'SKD Mode', 'MultiSharing(CMWS)', 'Developer Mode', and 'Advanced Separating(ADS)'. The 'Model Information' tab is visible, showing buttons for 'Model Information', 'Hardware Config', 'Signal Loss Config.', 'Engine Freq.', and 'OK'. The 'Test Process' tab has a red box around the 'IMEI Write' and 'IMEI Check' checkboxes, which are both checked. The 'Test Condition' tab has a red box around the 'Reset Loss Correction Count' button. The 'System Config.' tab has a red box around the 'IMEI SVC&Repair Option' button. The 'Model Information' tab has a red box around the 'OK' button.

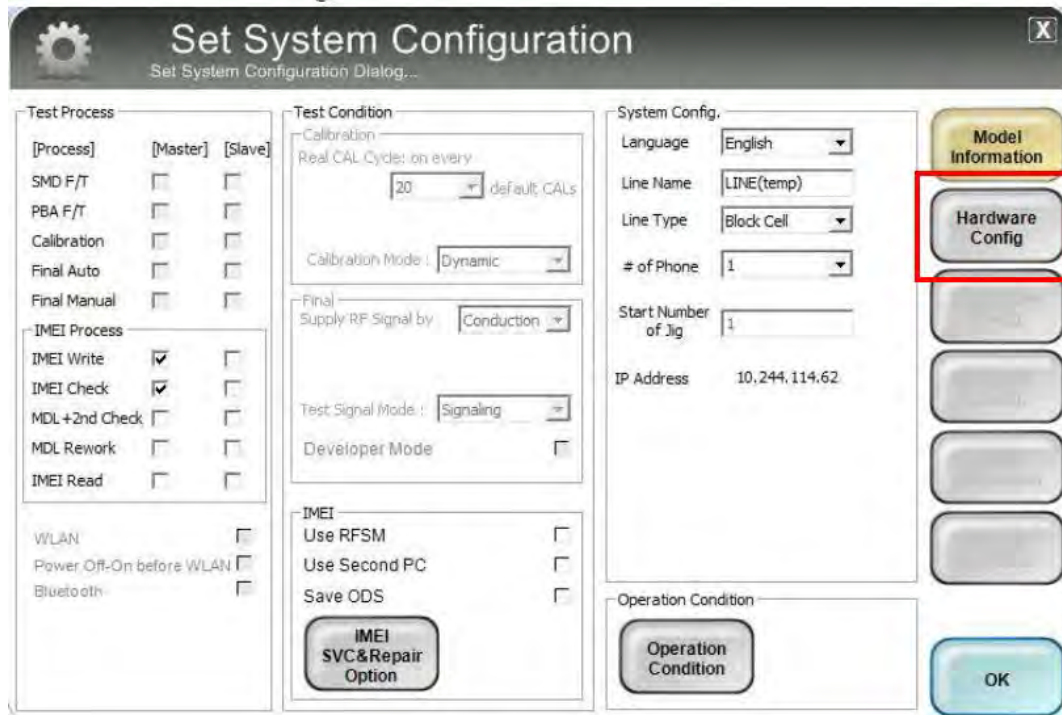
7. Check 'SVC , User Ticket No' and click OK



The image shows the 'IMEI SVC & Repair Option' dialog box. It has a title bar with a close button. The dialog box contains several checkboxes and dropdown menus. The 'SVC' checkbox is checked, and the 'User Ticket No' dropdown menu is selected. The 'FTR' dropdown menu is set to 'N/A'. The 'Rework' dropdown menu is set to 'N/A'. The 'Korean SVC' dropdown menu is set to 'Write'. The 'SELA MIAMI' dropdown menu is set to 'N/A'. The 'Local FOTA Check' checkbox is unchecked. The 'DEVELOPE' checkbox is unchecked. The 'Repair Board' checkbox is unchecked. The 'SVC Factory Reset' checkbox is unchecked. The 'Romania SVC' checkbox is unchecked. The 'Argentina SKD' checkbox is unchecked. The 'Initial PGM(SVC)' checkbox is unchecked. The 'Turkey' checkbox is unchecked. The 'ATT Rework' checkbox is unchecked. The 'Slovakia SVC' checkbox is unchecked. The 'IMEI Clear(Factory)' checkbox is unchecked. The 'GED 2nd Inspection' checkbox is unchecked. The 'Outgoing Inspection Check' checkbox is unchecked. The 'SBSC(PBA) SVC' checkbox is unchecked. The 'OK' and 'CANCEL' buttons are at the bottom right.

6. Level 1 Repair

8. Click 'Hardware Config'



Set System Configuration
Set System Configuration Dialog...

Test Process

[Process]	[Master]	[Slave]
SMD F/T	<input type="checkbox"/>	<input type="checkbox"/>
PBA F/T	<input type="checkbox"/>	<input type="checkbox"/>
Calibration	<input type="checkbox"/>	<input type="checkbox"/>
Final Auto	<input type="checkbox"/>	<input type="checkbox"/>
Final Manual	<input type="checkbox"/>	<input type="checkbox"/>

IMEI Process

IMEI Write	<input checked="" type="checkbox"/>	<input type="checkbox"/>
IMEI Check	<input checked="" type="checkbox"/>	<input type="checkbox"/>
MDL +2nd Check	<input type="checkbox"/>	<input type="checkbox"/>
MDL Rework	<input type="checkbox"/>	<input type="checkbox"/>
IMEI Read	<input type="checkbox"/>	<input type="checkbox"/>

WLAN ☐
Power Off-On before WLAN ☐
Bluetooth ☐

Test Condition

Calibration
Real CAL Cycle: on every default: CALs

Calibration Mode:

Final
Supply RF Signal by:

Test Signal Mode:

Developer Mode ☐

IMEI
Use RFSM ☐
Use Second PC ☐
Save ODS ☐

IMEI SVC&Repair Option

System Config.

Language:

Line Name:

Line Type:

of Phone:

Start Number of Jig:

IP Address: 10.244.114.62

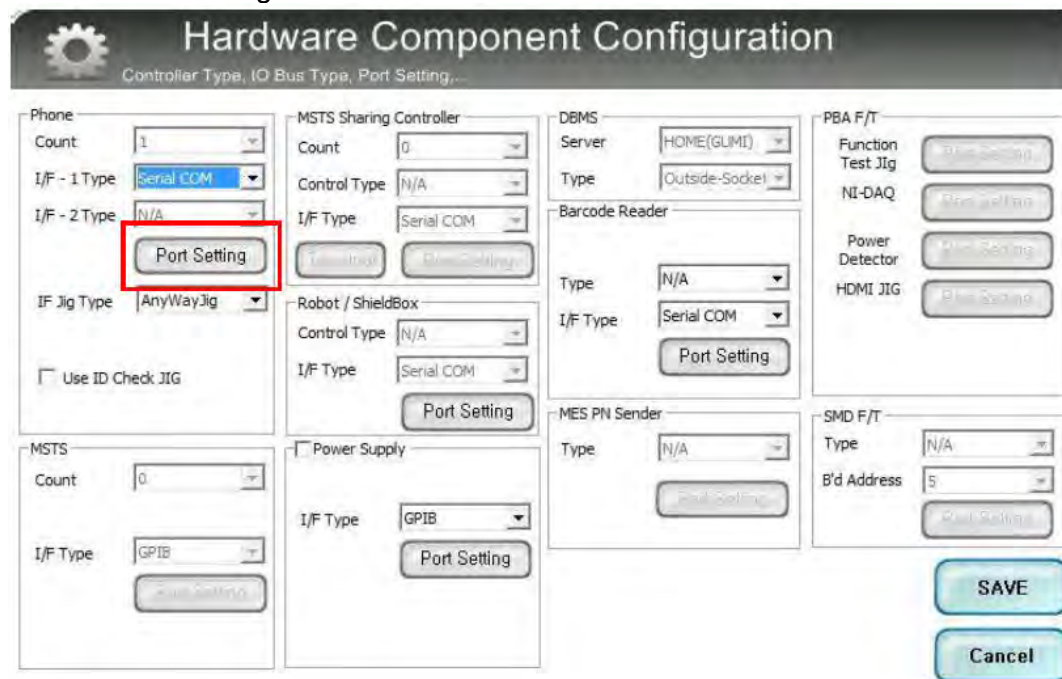
Operation Condition

Model Information

Hardware Config

OK

9. Click 'Port Setting'



Hardware Component Configuration
Controller Type, IO Bus Type, Port Setting...

Phone

Count:

I/F - 1 Type:

I/F - 2 Type:

Port Setting

I/F Jig Type:

☐ Use ID Check JIG

MSTS

Count:

I/F Type:

MSTS Sharing Controller

Count:

Control Type:

I/F Type:

Robot / ShieldBox

Control Type:

I/F Type:

Port Setting

Power Supply

I/F Type:

Port Setting

DBMS

Server:

Type:

Barcode Reader

Type:

I/F Type:

Port Setting

MES PN Sender

Type:

Port Setting

PBA F/T

Function Test Jig:

NI-DAQ:

Power Detector:

HDMI JIG:

SMD F/T

Type:

B'd Address:

Port Setting

SAVE

Cancel

6. Level 1 Repair

10. Select Port Number and SAVE

Set IO BUS Configuration

Phone IO Bus Setting

Common

BaudRate: 115200
Data Bit: 8
Parity: No
Stop Bit: 1

No.	Port #1
1	1

SAVE

Cancel

11. Click OK to proceed

Set System Configuration

Set System Configuration Dialog...

Test Process

[Process] [Master] [Slave]

SMD F/T ☐ ☐ ☐

PBA F/T ☐ ☐ ☐

Calibration ☐ ☐ ☐

Final Auto ☐ ☐ ☐

Final Manual ☐ ☐ ☐

IMEI Process

IMEI Write ☒ ☐ ☐

IMEI Check ☒ ☐ ☐

MDL+2nd Check ☐ ☐ ☐

MDL Rework ☐ ☐ ☐

IMEI Read ☐ ☐ ☐

WLAN ☐

Power Off-On before WLAN ☐

Bluetooth ☐

Test Condition

Calibration

Real CAL Cycles on every: 20 default CALs

Calibration Mode: Dynamic

Final Supply RF Signal by: Conduction

Test Signal Mode: Signaling

Developer Mode ☐

IMEI

Use RFSM ☐

Use Second PC ☐

Save ODS ☐

IMEI SVC&Repair Option

System Config.

Language: English

Line Name: LINE(temp)

Line Type: Block Cell

of Phone: 1

Start Number of Jig: 1

IP Address: 10.244.114.62

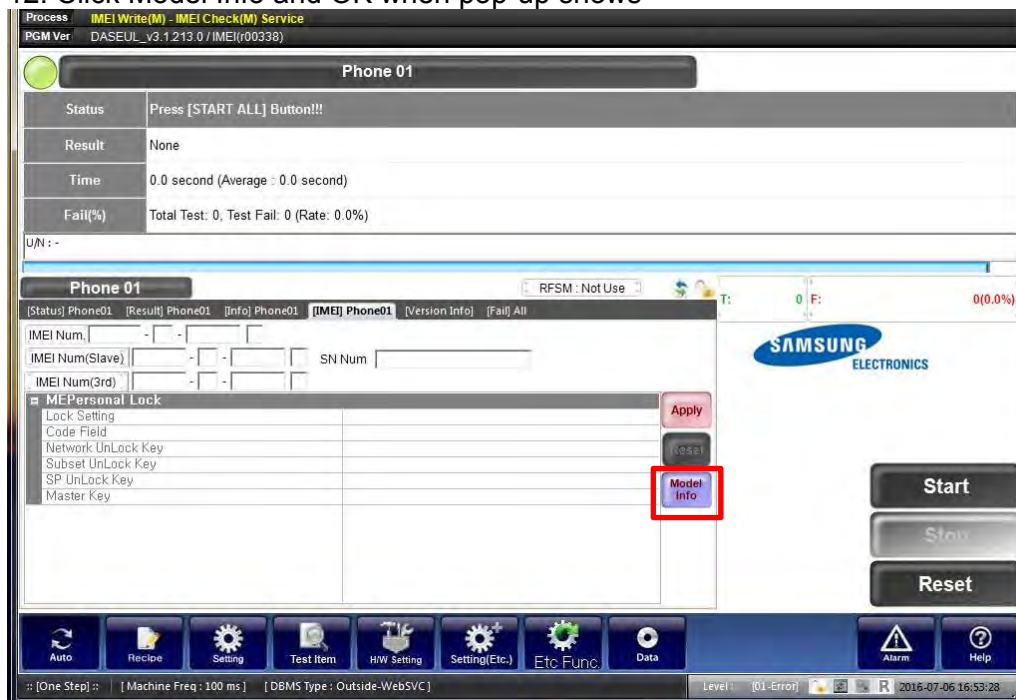
Operation Condition

Operation Condition

OK

6. Level 1 Repair

12. Click Model Info and OK when pop-up shows



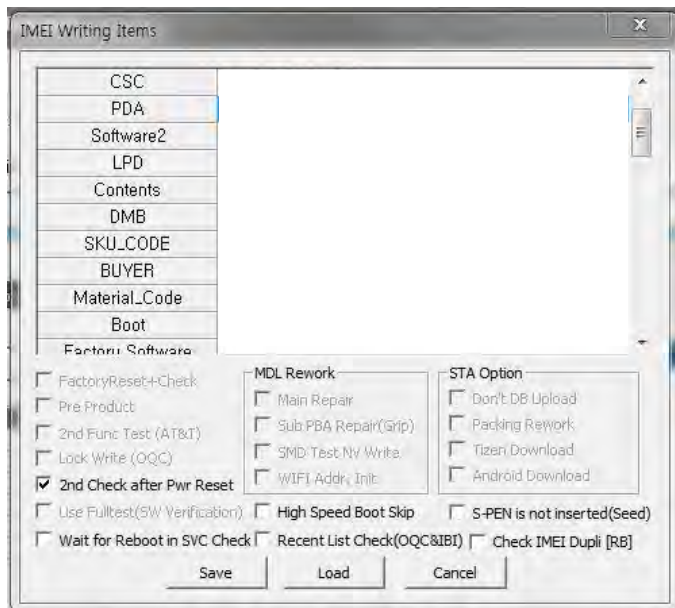
13. Click OK



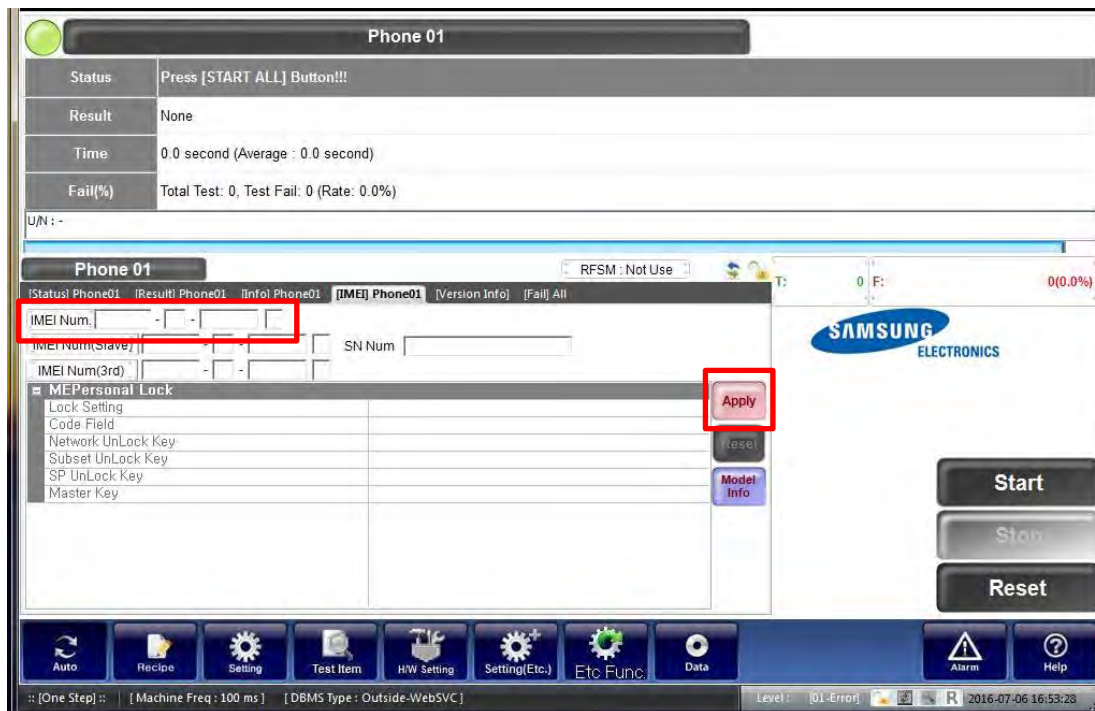
6. Level 1 Repair

14. Input SKU_CODE and BUYER, then click Save button.

※ Refer to HHPsvc→IMEI Review to check SKU Code and buyer

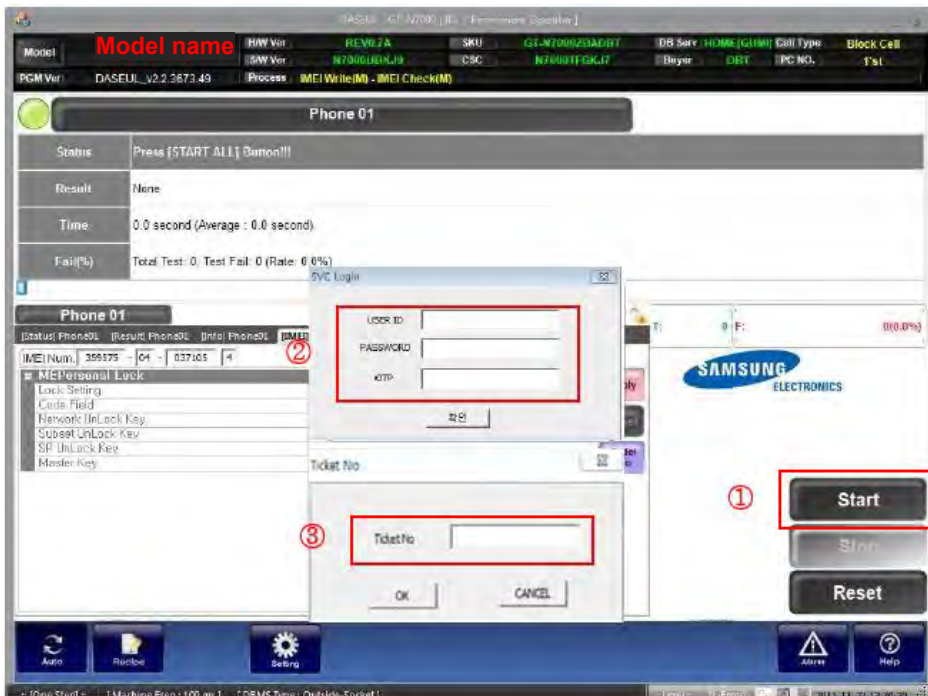


15. Input IMEI Number and click Apply



6. Level 1 Repair

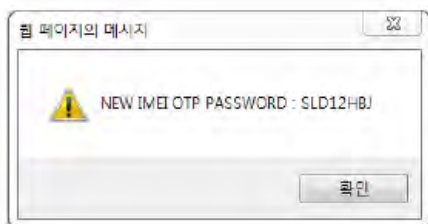
16. ① Click Start → ② Input IMEI writing ID and Password & OTP → ③ Input Ticket No



※ OTP(One time Password) : OTP is valid for 6 hours.

After that, you can get new OTP by click the “Forgotten your IMEI OTP PW or Create new IMEI OTP PW” button.

🔗 OTP Location : GSPN → Knowledge → HHP svc → Home



9. Reference Abbreviation

Reference Abbreviation

- **AAC**: Advanced Audio Coding.
- **AVC** : Advanced Video Coding.
- **BER** : Bit Error Rate
- **BPSK**: Binary Phase Shift Keying
- **CA** : Conditional Access
- **CDM** : Code Division Multiplexing
- **C/I** : Carrier to Interference
- **DMB** : Digital Multimedia Broadcasting
- **EN** : European Standard
- **ES** : Elementary Stream
- **ETSI**: European Telecommunications Standards Institute
- **MPEG**: Moving Picture Experts Group
- **PN** : Pseudo-random Noise
- **PS** : Pilot Symbol
- **QPSK**: Quadrature Phase Shift Keying
- **RS** : Reed-Solomon
- **SI** : Service Information
- **TDM** : Time Division Multiplexing
- **TS** : Transport Stream